Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note: Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

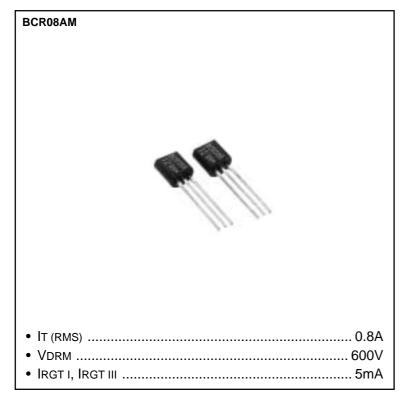
Renesas Technology Corp. Customer Support Dept. April 1, 2003

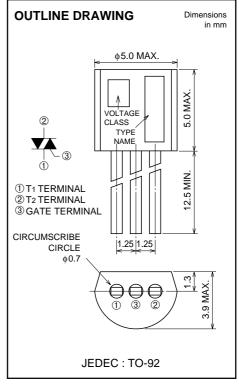


MITSUBISHI SEMICONDUCTOR <TRIAC>

BCR08AM

LOW POWER USE PLANAR PASSIVATION TYPE





APPLICATION

Electric fan, air cleaner, other general purpose control applications

MAXIMUM RATINGS

Symbol	Parameter	Voltage class	Unit
		12	Offic
VDRM	Repetitive peak off-state voltage *1	600	V
VDSM	Non-repetitive peak off-state voltage *1	720	V

Symbol	Parameter	Conditions	Ratings	Unit
IT (RMS)	RMS on-state current	Commercial frequency, sine full wave 360° conduction, Tc=56°C	0.8	Α
ITSM	Surge on-state current	60Hz sinewave 1 full cycle, peak value, non-repetitive	8	Α
I ² t	I ² t for fusing	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current	0.26	A ² s
Рсм	Peak gate power dissipation		1	W
PG (AV)	Average gate power dissipation		0.1	W
Vgм	Peak gate voltage		6	V
IGМ	Peak gate current		0.5	Α
Tj	Junction temperature		-40 ~ +125	°C
Tstg	Storage temperature		-40 ~ +125	°C
_	Weight	Typical value	0.23	g

*1. Gate open.



LOW POWER USE PLANAR PASSIVATION TYPE

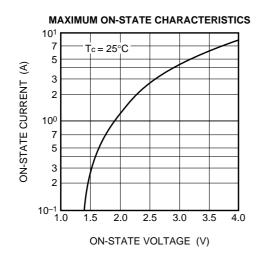
ELECTRICAL CHARACTERISTICS

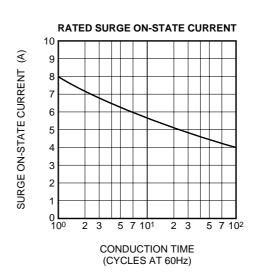
O make at	Parameter			Limits			Llade
Symbol			Test conditions		Тур.	Max.	Unit
IDRM	Repetitive peak off-state current		Тj=125°C, VDRм applied	_	_	1.0	mA
Vтм	On-state voltage		Tc=25°C, ITM=1.2A, Instantaneous measurement	_	_	2.0	V
VRGT I	Cata trimman valta na *2	Ш	$T_{j=25^{\circ}C}$, $V_{D=6V}$, $R_{L=6\Omega}$, $R_{G=330\Omega}$	_	_	2.0	V
VRGT III	Gate trigger voltage *2	Ш		_	_	2.0	V
İRGT I	0-4-4	II	$T_{j=25^{\circ}C}$, $V_{D=6V}$, $R_{L=6\Omega}$, $R_{G=330\Omega}$	_	_	5	mA
IRGT III	Gate trigger current *2	Ш		_	_	5	mA
VGD	Gate non-trigger voltage		Tj=125°C, VD=1/2VDRM	0.1	_	_	V
Rth (j-c)	Thermal resistance		Junction to case *3	_	_	60	°C/W
(dv/dt)c	Critical-rate of rise of off-state commutating voltage	*4	Tj=125°C	0.5	_	_	V/μs

- *2. Measurment using the gate trigger characteristics measurement circuit.*3. Case temperature is measured at the T₂ terminal 1.5mm away from the molded case.
- *4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

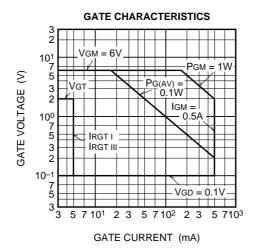
Test conditions	Commutating voltage and current waveforms (inductive load)
Junction temperature Tj=125°C	SUPPLY VOLTAGE → TIME
Rate of decay of on-state commutating current (di/dt)c=-0.4A/ms	MAIN CURRENT (di/dt)c MAIN MAIN
3. Peak off-state voltage VD=400V	VOLTAGE TIME (dv/dt)c VD

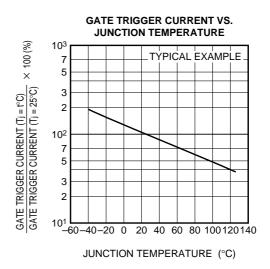
PERFORMANCE CURVES

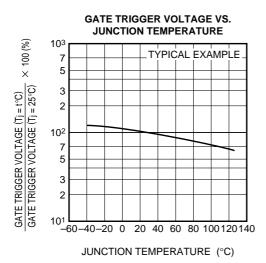


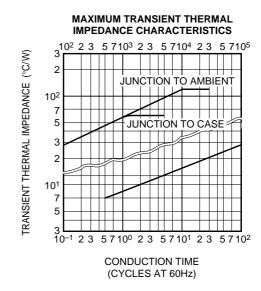


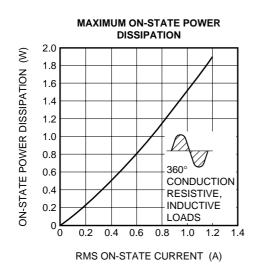
LOW POWER USE PLANAR PASSIVATION TYPE

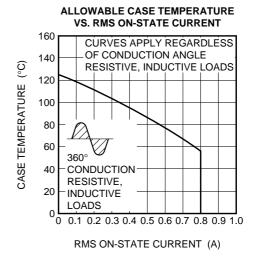






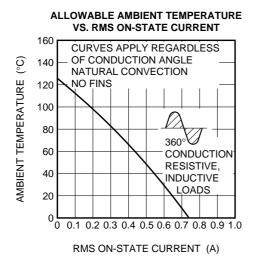


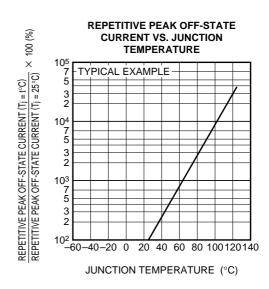


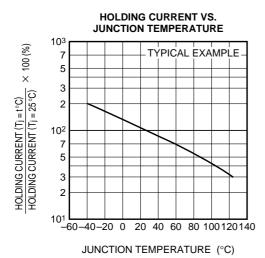


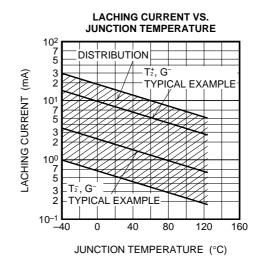
Renesas Technology Corp.

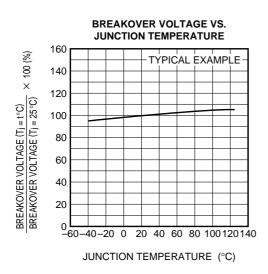
LOW POWER USE PLANAR PASSIVATION TYPE

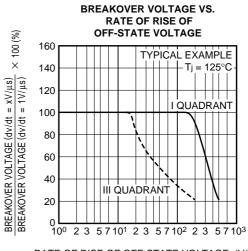






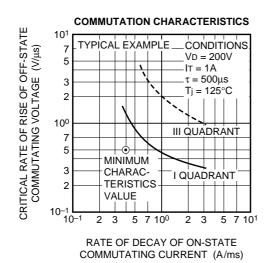






RATE OF RISE OF OFF-STATE VOLTAGE $\,(\mbox{V}/\mbox{$\mu$s})$

LOW POWER USE PLANAR PASSIVATION TYPE



GATE TRIGGER CURRENT VS. GATE CURRENT PULSE WIDTH 10³ × 100 (%) TYPICAL EXAMPLE 5 IRGT 3 GATE TRIGGER CURRENT (tw) 10² 5 3 2 2 3 5 7 10¹ 2 3 5 7 102

GATE CURRENT PULSE WIDTH (µs)

GATE TRIGGER CHARACTERISTICS
TEST CIRCUITS

